

Superior thermal interface via vertically aligned carbon nanotubes grown on graphite foils

Sabyasachi Ganguli^{a)}

Nanoelectronic Materials Branch, Materials & Manufacturing Directorate, Air Force Research Laboratory, Dayton, Ohio 45433; and University of Dayton Research Institute, Dayton, Ohio 45469

Ajit K. Roy

Nanoelectronic Materials Branch, Materials & Manufacturing Directorate, Air Force Research Laboratory, Dayton, Ohio 45433

Robert Wheeler

UES Inc., Dayton, Ohio 45432

Vikas Varshney

Nanoelectronic Materials Branch, Materials & Manufacturing Directorate, Air Force Research Laboratory, Dayton, Ohio 45433; and Universal Technology Corporation, Dayton, Ohio 45432

Feng Du and Liming Dai

Department of Chemical Engineering, Case Western Reserve University, Cleveland, Ohio 44106

(Received 26 April 2012; accepted 12 November 2012)

In an attempt to study the thermal transport at the interface between nanotubes and graphene, vertically aligned multiwalled carbon nanotubes (CNTs) were grown on graphite thin film substrates. A systematic cross-sectional probing of the materials' morphology of the interface by scanning electron microscopy and high-resolution transmission electron microscopy revealed that an excellent bond existed between the nanotubes and the substrate along some fraction of interface. Imaging and electron diffraction analyses performed at the boundary reveal a polycrystalline interfacial structure. Compositional probing along the interface by energy dispersive x-ray spectroscopy revealed that there were no catalyst particles or other impurities present. The estimated interfacial thermal resistance of lower than 5–7.5 (mm² K)/W suggests that this type of CNT/graphite interface could open up multiple routes toward the designing and development of advanced thermal interface materials for aerospace and nano-/microelectronics applications.

I. INTRODUCTION

The growing emergence of wide band gap semiconductors for power, radio-frequency (RF) electronics, and high power silicon microelectronics has accentuated the need for improved thermal interface materials (TIMs) in providing efficient management of the huge thermal load generated by these devices. The existing TIMs commonly used for such applications can be categorized as thermal grease-type interface materials, thermally conductive adhesives, and thermal tapes. In most thermal greases, high thermal conductivity originates from the filler particles, such as aluminum or silver powder. The thermal conductivity of the best thermal greases is on the order of 8–10 W/(m K).¹ Further, thermal greases are usually oil-based materials so their application is messy and difficult to apply in a thin uniform coating. In addition, these greases are not reusable and usually suffer from drying or voiding within the interface in applications that involve

high temperatures or extensive thermal cycling. This eventually increases the thermal barrier in a significant manner. On the other hand, thermal transport properties of thermal tapes and thermally conductive adhesives do not meet the thermal management and structural load requirements of the next generation aerospace structures.² These conventional techniques of thermal management relating to interface thermal loads are not an integral part of the packaging architecture and thus do not efficiently address the problems of interfacial thermal resistance, thermal expansion coefficient mismatches, etc. Hence, there is an emerging need for materials research to develop efficient TIMs that can be integrated with the package and address the problems associated with conventional thermal management techniques.

Carbon nanotubes (CNTs) have been proposed as a possible TIM to replace solders because of their excellent thermal properties and one-dimensional structure. Furthermore, it has been shown that CNTs can enhance mechanical compliance between the surfaces.¹ Huang et al.³ developed a TIM based on aligned CNTs embedded in an elastomeric matrix. Though they achieved a 120% enhancement of thermal conductivity using the nanocomposite film, the reported value of 1.21 W/(m K) was much less than

^{a)}Address all correspondence to this author.
e-mail: sabyasachi.ganguli@wpafb.af.mil
DOI: 10.1557/jmr.2012.401

Report Documentation Page				Form Approved OMB No. 0704-0188	
Public reporting burden for the collection of information is estimated to average 1 hour per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the collection of information. Send comments regarding this burden estimate or any other aspect of this collection of information, including suggestions for reducing this burden, to Washington Headquarters Services, Directorate for Information Operations and Reports, 1215 Jefferson Davis Highway, Suite 1204, Arlington VA 22202-4302. Respondents should be aware that notwithstanding any other provision of law, no person shall be subject to a penalty for failing to comply with a collection of information if it does not display a currently valid OMB control number.					
1. REPORT DATE 2012		2. REPORT TYPE		3. DATES COVERED 00-00-2012 to 00-00-2012	
4. TITLE AND SUBTITLE Superior thermal interface via vertically aligned carbon nanotubes grown on graphite foils				5a. CONTRACT NUMBER	
				5b. GRANT NUMBER	
				5c. PROGRAM ELEMENT NUMBER	
6. AUTHOR(S)				5d. PROJECT NUMBER	
				5e. TASK NUMBER	
				5f. WORK UNIT NUMBER	
7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) Case Western Reserve University, Department of Chemical Engineering, 10900 Euclid Avenue, Cleveland, OH, 44106				8. PERFORMING ORGANIZATION REPORT NUMBER	
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES)				10. SPONSOR/MONITOR'S ACRONYM(S)	
				11. SPONSOR/MONITOR'S REPORT NUMBER(S)	
12. DISTRIBUTION/AVAILABILITY STATEMENT Approved for public release; distribution unlimited					
13. SUPPLEMENTARY NOTES					
14. ABSTRACT					
15. SUBJECT TERMS					
16. SECURITY CLASSIFICATION OF:			17. LIMITATION OF ABSTRACT Same as Report (SAR)	18. NUMBER OF PAGES 7	19a. NAME OF RESPONSIBLE PERSON
a. REPORT unclassified	b. ABSTRACT unclassified	c. THIS PAGE unclassified			

that of the value predicted by assuming total thermal transport through the CNTs and matrix interface (i.e., perfect thermal interface).³ While Huang's work improved the thermal conductivity of the epoxy matrix, in spite of using CNTs, it does not meet the thermal conductivity of thermal grease-type materials, which is around 8–10 W/(m K). This is because of significant resistance to heat flow at the CNT/polymer interface (phonon scattering), which is caused by the acoustic impedance mismatch.

Recent experiments by several researchers have shown that a dense array of vertically aligned CNTs grown on silicon and copper substrates can provide thermal resistance values, which are less than 20 (mm² K)/W.^{1,2,4–9} Comparatively, lead-free solders on the market possess similar thermal resistances that range from 7 to 28 (mm² K)/W.¹ A recent attempt by Ganguli et al.² to reduce the interfacial thermal resistance in adhesively bonded structures resulted in high through thickness thermal conductivity [~ 262 W/(m K)] of the developed device by incorporating aligned multiwalled carbon nanotubes (MWCNTs) in adhesive joints when compared to that of less than 1 W/(m K) without the MWCNTs. They also calculated a thermal interface resistance of 12 (mm² K)/W in the adhesively bonded joint under study.

Though the aforementioned study achieved superior thermal transport properties, the processing and scale-up of the developed process would be prohibitively expensive. Furthermore, the Au–In interface used in this study is not structurally durable. Even with the right choice of materials as well as the right type of bonding at the interface, one that matches the vibrational density of states of interface components, it is necessary to reduce the interface thermal resistance even further [below ~ 12 (mm² K)/W]. Recent molecular modeling studies have predicted that a three-dimensional hierarchical structure comprising nanotubes bonded on graphene layers can be potentially used as the next generation TIM with significantly reduced interfacial thermal resistance, resulting from all carbon atomic configuration at the CNT/graphene junction.¹⁰ Previous experimental efforts to realize this structure have not investigated the thermal transport behavior at the nanotube graphite junction.^{11–13} Toward experimental realization of such interface morphology, we present a growth and characterization scheme of vertically aligned multiwalled carbon nanotubes (VAMWCNTs) on graphite thin film foils. In the current study, we have demonstrated that catalyst-free covalent bonding between the nanotubes and the graphitic substrate ensures a significant reduction of the interfacial thermal resistance leading the way to a new generation of advanced thermal interfacial materials.

II. EXPERIMENTAL DETAILS

Toward obtaining a self-similar atomic configuration at the CNT–graphene junction, as-purchased graphite thin film

was coated with a thin layer of silicon oxide at 1100 °C in a tube furnace by introducing silicon tetrachloride with a gas flow of argon (300 mL/min) and hydrogen (30 mL/min) in the presence of a trace amount of air for 10 min. The SiO₂ coating was used to facilitate the growth of VAMWCNTs on the graphite substrate by the pyrolysis of iron phthalocyanine under argon/hydrogen atmosphere at 800–1100 °C. The detailed procedure has been reported elsewhere.^{14,15} The morphology of the as-grown VAMWCNTs was characterized by high-resolution scanning electron microscopy (SEM). A FEI Titan 80–300 transmission electron microscope (TEM; FEI Inc., Hillsboro, OR) operating at 80 kV was used to characterize the interfaces for further detail insights. The TEM specimens were prepared for microtoming according to the procedure described in Supporting Information A. As the nanotubes are extremely beam sensitive, microscope images were taken quickly after all the adjustments were made at an adjacent area of the specimen. The thermal diffusivity and conductivity of the specimens were characterized by a Netzsch laser flash thermal analyzer LFA 457 (NETZSCH Instruments North America, LLC, Pittsburgh, PA).

III. RESULTS AND DISCUSSION

A. Morphological characterization

Multiple characterization tools are used to analyze the materials morphology of the CNT–graphene junction. A SEM image showing the top surface of the as-produced VAMWCNTs that were grown on the graphitic surface is given in Fig. 1. A cross-sectional view of the VAMWCNT array, shown in Fig. 2, depicts a general vertical alignment. While the observed alignment is not perfect, it is clear that the upper regions of the nanotubes are mechanically interlocked, where nanotubes have physical entanglements, chemical fusing, as well as multiple branched structures. To get an estimate of the aerial density of the nanotubes for thermal characterization (discussed later), a count of nanotubes within a given area has been made. However, as the

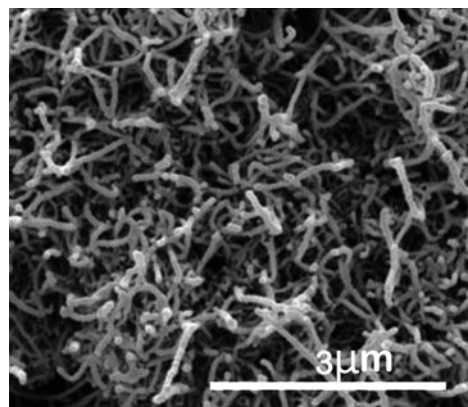


FIG. 1. SEM micrograph of VAMWCNT array (top view). We observe mechanical interlocking of the nanotubes.

top layer of the nanotubes was mechanically interlocked, it is extremely difficult to get an accurate estimate of the number density of the CNTs without further surface modifications. Thus, the top layer of the nanotubes was etched with a gallium ion beam for 30 min in a focused ion beam microscope. The resulting surface is shown in Fig. 3. After the nanotubes were successfully isolated by etching the entangled top surface, we estimated the percentage of nanotubes in a given area by performing a gray scale histogram analysis on the etched image in Adobe Photoshop® to be $\sim 20\%$. It is to be noted that this value is an upper bound as contributions from bent tubes have not been eliminated from the analysis.

The detailed structure of the graphite/CNT interface was studied by multiple visualization and characterization techniques. This structure is evidenced by the lattice fringe patterns at the interface where high-resolution transmission electron microscopy (HRTEM) was performed. In this context, first, the lower magnification TEM images of the specimen are shown in Fig. 4. Here, the white line in Fig. 4 shows the interface between the nanotubes and the graphite foil. To further investigate the nature of the

bonding between the nanotubes and the graphite foils, lattice image micrographs were obtained as exemplified in Fig. 5. It was observed that crystalline lattice fringe patterns of the nanotubes and the graphite foil are, in fact, well aligned. The degree of alignment was further supported by the fringe spacing (~ 0.34 nm), which corresponds to the graphitic interlayer spacing (along 002 direction) as well as wall separation between MWCNTs.

To further assess the orientational order of the atomic entities at the interface, selected area electron diffraction patterns were obtained. The pattern was recorded from the area shown in Fig. 5 containing both graphite and CNTs and is presented in Fig. 6. The electron diffraction patterns of the interface between the nanotubes and the substrate show well-defined polycrystalline hexagonal patterns associated with sp^2 hexagonal atomic arrangements of carbon atoms. These diffraction data further confirmed that at some locations, the atomic arrangement at the interface is entirely crystalline and should correspond to a well-bonded interface.

Though the HRTEM images showed good bonding at the interface, the chemical makeup at the interface was

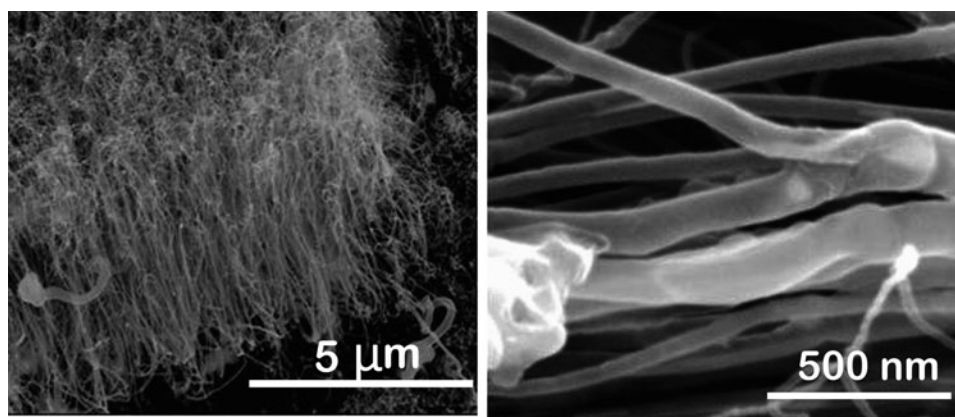


FIG. 2. SEM micrograph of the aligned nanotubes (cross-sectional view). The left image shows that the nanotubes are generally vertically aligned. A closer look at the nanotubes (right image) shows branched nanotube structures, which result in lowering of the thermal transport in the longitudinal axis of the tubes.

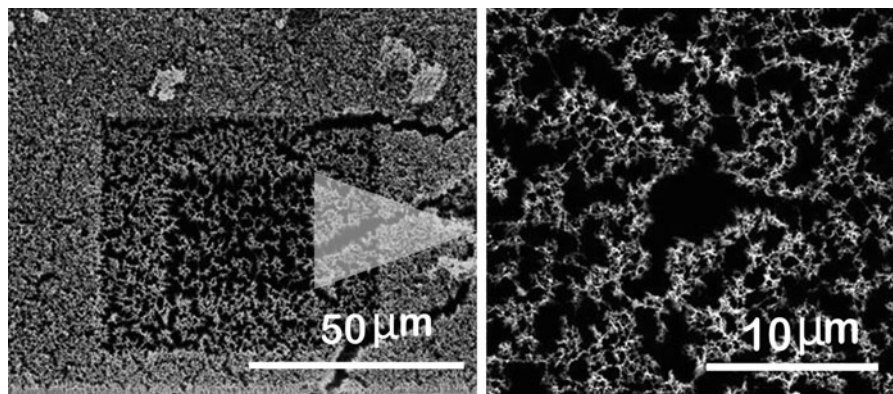


FIG. 3. Ion-etched nanotube surface for enabling histogram analysis. After etching, we observe the nanotube tips represented by the bright patterns in the SEM image on the right. Histogram analysis on the right image gives us an upper bound of the nanotube aerial density.

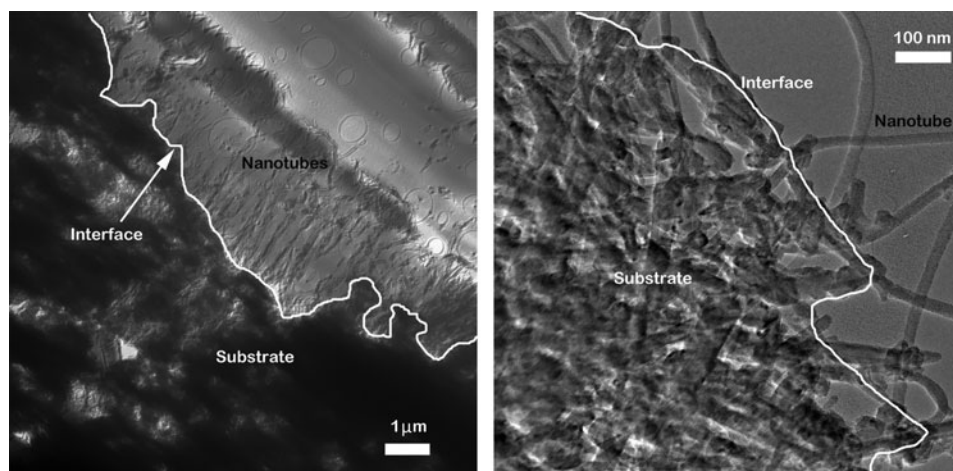


FIG. 4. TEM cross-sectional micrograph of the studied specimen showing the interface. The image on the left is a lower magnification view of the image. The image on the right is a higher magnification view of a portion of the interface.

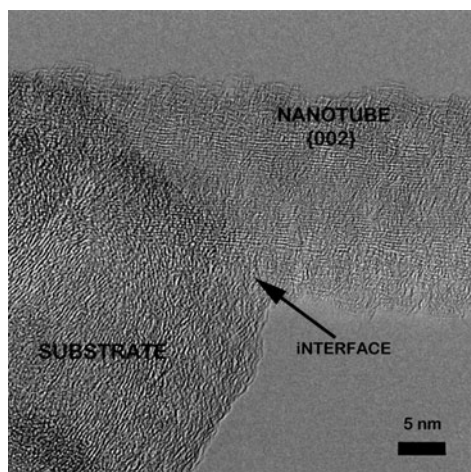


FIG. 5. HRTEM lattice image at the interface of the nanotube and the substrate. The crystalline lattice fringe patterns of the nanotubes and the graphite foil are well aligned.

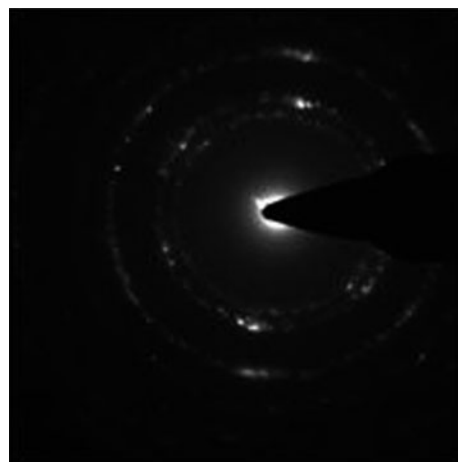


FIG. 6. The electron diffraction patterns of the interface between the nanotubes and the substrate show well-defined polycrystalline hexagonal patterns associated with sp^2 hexagonal atomic arrangements of carbon atoms.

analyzed to identify the possible presence of any catalyst particles or other foreign materials that may inhibit thermal transport across the CNT/graphite interface. Figure 7 shows a scanning transmission electron microscopy (STEM) of the interface. Energy dispersive x-ray spectroscopy (EDS) was performed on the selected areas outlined by a box for area 1 and a circle for area 2 in the Fig. 7. The box (area 1) represents a CNT–graphene junction and circle (area 2) is a catalyst-rich location. The EDS spectrum for area 1 is presented in Fig. 8(a). Here, the predominant presence of carbon from the nanotubes and the substrate was observed along with small fractions of silicon and oxygen (silica), possibly originating from the coating on the substrate as previously discussed in Sec. II. The EDS spectrum for area 2 is presented in Fig. 8(b). Here, in addition to the presence of carbon (from the nanotubes), significant proportions of iron (from the catalyst used in the growth of the nanotubes)

and copper (from the TEM grid used in this study) were observed as well. This analysis suggests that the bonded CNT/graphite interface is virtually defect and contamination free. For the sake of completeness, it should be mentioned here that near the bonded CNT/graphitic interface, branched nanotubes and bamboo-like node structures as observed by the SEM technique were also observed in the TEM studies. A representative TEM image (Fig. 9) shows the mentioned branched and bamboo-like nanotubes. This nanotube structure is expected to exhibit an intrinsic reduction in thermal transport along the nanotube length due to poor continuity of the atomic layers.

B. Laser flash analysis

The bulk thermal properties of the bare graphite foil and the nanotube grown on the graphite foil were measured by a Netzsch LFA 457 laser flash thermal diffusivity system. The laser flash technique (or heat pulse) allows the

measurement of the thermal diffusivity (α) of solid materials. It consists of applying a short duration (<1 ms) heat pulse to one face of a parallel sided sample and monitoring the temperature rise on the opposite face as a function of time. This temperature rise is measured with an infrared detector. Thermal diffusivity (α) can then be calculated using Eq. (1):

$$\alpha = \frac{\varpi d^2}{\pi t_{1/2}} \quad , \quad (1)$$

where ϖ is a constant, d is the thickness of the specimen, $t_{1/2}$ is the time for the rear surface temperature to reach half its maximum value. Sample weight and dimensions of the samples were accurately measured to calculate the density using a simple ratio of measured weight to volume. Finally, using the heat capacity (C_p) measured using a TA Instruments modulated DSC Q5000 instrument (TA Instruments Inc., New Castle, DE), the density (ρ), and the thermal diffusivity (α), the thermal conductivity (k) of the samples were obtained at 24 °C from Eq. (2):

$$k = C_p \rho \alpha \quad . \quad (2)$$

Thermal resistance (R), a measure to determine the thermal transport performance at an interface, is defined by the ratio of the thickness (d) to the thermal conductivity (k). The values of R were calculated both for the bare graphite foil and the nanotube modified graphite foil. The results of the thermal measurements and calculated thermal resistance are presented in Table I. These data illustrate that introducing the nanotube layer with a thickness of 25 μm only increased the overall thermal device resistance by ~ 10 ($\text{mm}^2 \text{K}/\text{W}$).

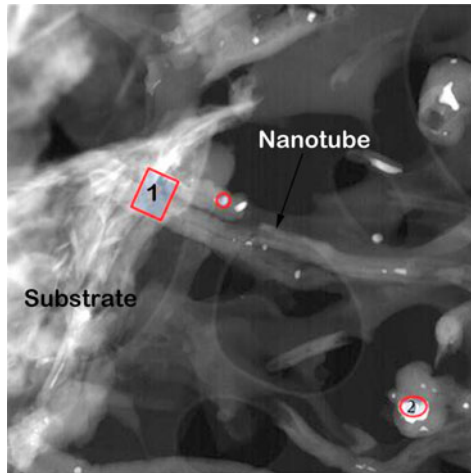


FIG. 7. STEM images of the interface showing nanotubes, substrate, and catalyst particles. The graphite foil substrate is to the left in this image. EDS spectrum were acquired from area 1 and 2 in the image.

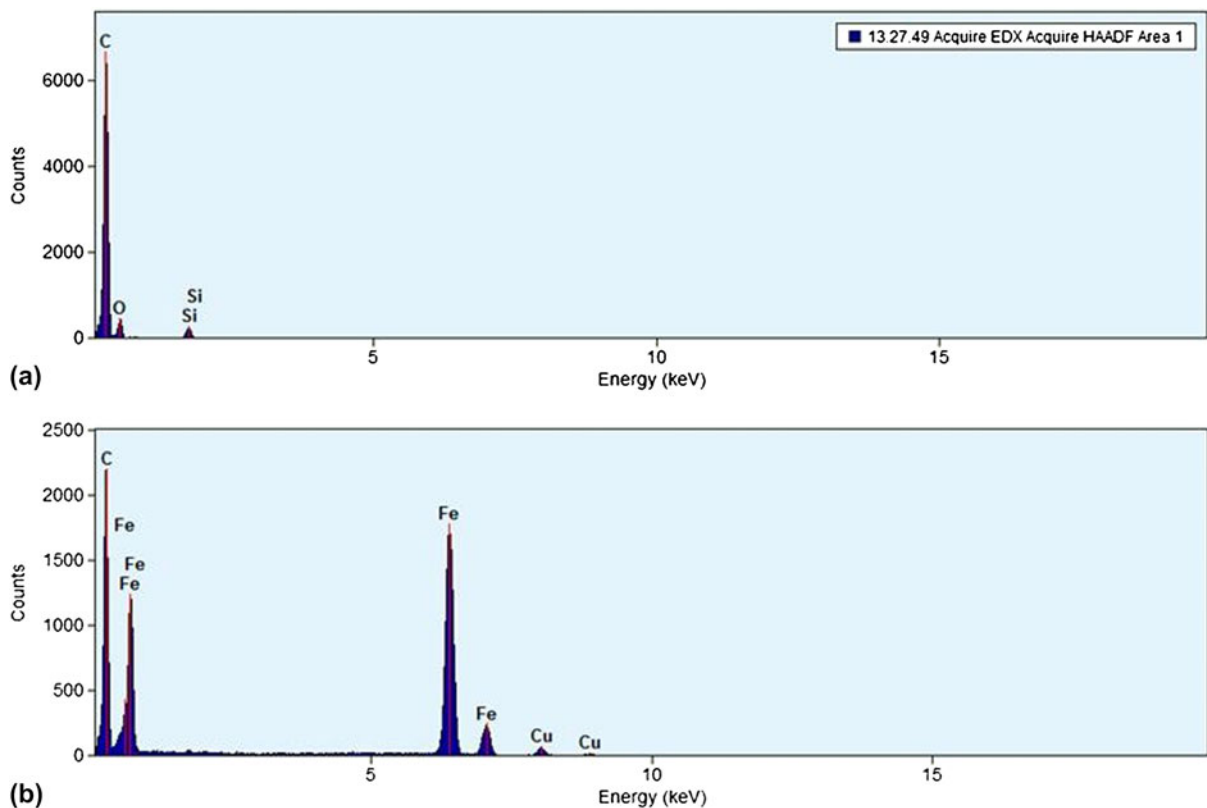


FIG. 8. EDS spectrum from the interface of nanotube and graphite thin film: (a) EDS spectrum from area 1 in Fig. 7; (b) EDS spectrum from area 2 in Fig. 7.

This resistance change results from the interface thermal resistance at the CNT/graphite junction as well as the thermal resistance offered by the 25- μm -thick vertically aligned nanotube forest participating in the thermal transport. We now proceed to estimate the interface thermal resistance using a simple resistance model.

In this context, a schematic illustration of the specimen configuration along with the thermal resistance diagram is presented in Fig. 10. While the thermal resistance of the substrate (R_{GF}) is known experimentally [~ 23 ($\text{mm}^2 \text{ K}/\text{W}$)], the interface thermal resistance (R_{INT}) and that of nanotubes' forest (R_{CNT}) need to be estimated, given that $R_{\text{INT}} + R_{\text{CNT}} = \sim 10$ ($\text{K mm}^2/\text{W}$). Now, R_{NT} can be estimated easily if the effective thermal conductivity of 25- μm nanotube forest (k_{eff}) is known by using the simple expression, $R_{\text{CNT}} = t_{\text{CNT}}/k_{\text{eff}}$, where t_{CNT} is the thickness of the nanotube forest (25 μm in this case). Here, it is easy to observe that if we assume

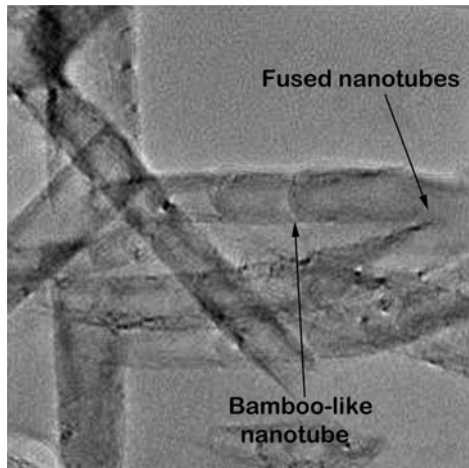


FIG. 9. TEM images of the nanotubes. Similar to the SEM images, we see branched and other defects along the length in the nanotubes.

$R_{\text{INT}} \sim 0$ (i.e., if the CNT–graphene interface resistance is negligible), the value of $k_{\text{eff}} \sim 2.5$ $\text{W}/(\text{m K})$, which is unrealistically a low value for MWCNT of its length (i.e., 25 μm). Thus, the laser flash measurement implies that CNT–graphene interface does exhibits, although low, a finite interface thermal resistance (R_{INT}).

While there is no direct way of measuring effective thermal conductivity of our films (as the nanotubes are bonded and not possible to peel off from the graphitic substrate), we can however estimate the value of k_{eff} from literature. On revisiting published literature on thermal conductivity of MWCNT forests, we find that Yi et al.¹⁶ measured the thermal conductivity of similar MWCNT mats by the 3- ω technique and reported the value of ~ 20 $\text{W}/(\text{m K})$. Unlike their study, we observe extensive evidence of curved, branched, and bamboo-like nanotube structures from the microscopy. Such defects increase the tendency of phonon scattering along the length of the nanotube and decrease their intrinsic thermal conductivity. Hence, the k_{eff} value reported here should be much lower than that of Yi et al.¹⁶ Considering the areal coverage of the MWCNTs (Fig. 3), their average diameter and thickness, and cylindrical packing efficiency, we estimate our k_{eff} value to be ~ 7 $\text{W}/(\text{m K})$ (see Supporting Information B for further details). This range leads to the estimated value of R_{INT} to be ~ 6 ($\text{mm}^2 \text{ K}/\text{W}$), which to our knowledge is the lowest value published in the literature.

It is important to note that as shown in the present study through different SEM and TEM images, not all the nanotubes from the VAMWCNTs forest made the perfect “bonded” contact with the graphitic substrate. The rest were primarily physisorbed on to the substrate and were interacting with the substrate by the van der Waals interactions, predominantly. This fractional value is of great significance interest as this suggests that if all the nanotubes were, in fact, covalently bonded to the graphitic substrate, the interface

TABLE I. Bulk thermal transport properties of the nanotube on graphite specimen.

Specimen	C_p [$\text{J}/(\text{g K})$]	α (mm^2/s)	ρ (g/cc)	d (mm)	k [$\text{W}/(\text{m K})$]	R [$(\text{K mm}^2)/\text{W}$]
Bare graphite foil	0.7	5.2	1.75	0.146	6.37	22.92
Vertically aligned carbon nanotube (VACNT) on graphite foil	0.7	6.5	1.1	0.171	5.1	33.55

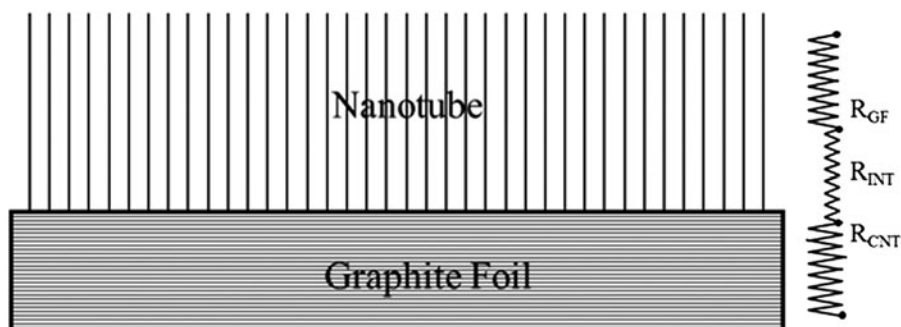


FIG. 10. Schematic of the specimen configuration and resistance circuit diagram.

thermal resistance could be reduced by a considerable amount (possibly, be an order of magnitude or more).

IV. CONCLUSIONS

In spite of excellent thermal behavior of CNTs, it is apparent that many challenges still need to be overcome before CNT-based devices can be incorporated in the next generation advanced TIMs. The primary challenge lies in the engineering of the CNT tips for better thermal energy transmission by reducing phonon scattering at such interfaces. In this study, we have successfully synthesized and characterized a novel graphite–VAMWCNT interface toward the development of next generation TIM devices. Using different techniques, we have demonstrated that excellent bonding between individual nanotubes and the graphitic substrate can be achieved at the local level. Further chemical analysis of the interface revealed that the bonded interface was free of catalyst and foreign particles. The low interface thermal resistance value of ~ 6 (mm² K)/W suggests that such a bonded interface would lead to superior thermal energy transmission at nanotube tips. In this study, although only a fraction of the nanotubes from the VAMWCNTs forest made the perfect “bonded” contact with the graphitic substrate (the remaining were interacting through the van der Waals interactions), we foresee that if such excellent bonding can be replicated with much higher success, such interfaces must be considered as an excellent candidate toward the development of next generation of advanced TIMs.

ACKNOWLEDGMENTS

S.G. acknowledges support through U.S. Air Force Contract No. FA8650-05-5052. Authors also acknowledge additional support from Air Force Office of Scientific Research (Task 2302BR7P, Program manager: Dr. Byung-Lip Lee).

REFERENCES

1. J. Liu, B. Michel, M. Rencz, C. Tantolin, C. Sarno, R. Miessner, K. Schuett, X. Tang, and A. Ziaei: Recent progress of thermal interface material research – an overview, in *THERMINIC 2008* (EDA Publishing, Rome, Italy, 2008); pp. 156.
2. S. Ganguli, S. Sihn, A.K. Roy, L.M. Dai, and L. Qu: Metalized nanotube tips improve through thickness thermal conductivity in adhesive joints. *J. Nanosci. Nanotechnol.* **9**, 1727 (2009).
3. H. Huang, C.H. Liu, Y. Wu, and S. Fan: Aligned carbon nanotube composite films for thermal management. *Adv. Mater.* **17**(13), 1652 (2005).
4. P. Amama, B. Cola, T. Sands, X. Xu, and T.S. Fisher: Dendrimer-assisted controlled growth of carbon nanotubes for enhanced thermal interface conductance. *Nanotechnology* **18**(38), 385303–385307 (2007).
5. B.A. Cola, J. Xu, C. Cheng, X. Xu, T.S. Fisher, and H. Hu: Photoacoustic characterization of carbon nanotube array thermal interfaces. *J. Appl. Phys.* **101**(5), 054313 (2007).
6. B.A. Cola, X. Xu, and T.S. Fisher: Increased real contact in thermal interfaces: A carbon nanotube/foil material. *Appl. Phys. Lett.* **90**(9), 093513 (2007).
7. Q. Ngo, B.A. Cruden, A.M. Cassell, G. Sims, M. Meyyappan, J. Li, and C.Y. Yang: Thermal interface properties of Cu-filled vertically aligned carbon nanofiber arrays. *Nano Lett.* **4**(12), 2403 (2004).
8. M.A. Panzer, G. Zhang, D. Mann, X. Hu, E. Pop, H. Dai, and K.E. Goodson: Thermal properties of metal-coated vertically aligned single-wall nanotube arrays. *J. Heat Transfer* **130**(5), 052401 (2008).
9. T. Tong, Y. Zhao, L. Delzeit, A. Kashani, M. Meyyappan, and A. Majumdar: Dense vertically aligned multiwalled carbon nanotube arrays as thermal interface materials. *IEEE Trans. Compon. Packag. Technol.* **30**(1), 92 (2007).
10. V. Varshney, S. Patnaik, A.K. Roy, G. Froudakis, and B.L. Farmer: Modelling of thermal transport in pillared-graphene architectures. *ACS Nano* **4**(2), 1153 (2010).
11. L.L. Zhang, Z. Xiong, and X.S. Zhao: Pillaring chemically exfoliated graphene oxide with carbon nanotubes for photocatalytic degradation of dyes under visible light irradiation. *ACS Nano* **4**, 7030–7036 (2010).
12. R.K. Paul, M. Ghazinejad, M. Penchev, J. Lin, and C.S. Ozkan: Synthesis of pillared graphene nanostructure: A counterpart of three dimensional carbon architectures. *Small* **6**(20), 2309 (2010).
13. V. Jousseume, J. Cuzzocrea, N. Bernier, and V.T. Renard: Few graphene layers/carbon nanotube composites grown at complementary-metal-oxide-semiconductor compatible temperature. *Appl. Phys. Lett.* **98**(123103), 1 (2011).
14. S.M. Huang, L. Dai, and A.W.H. Mau: Patterned growth and contact transfer of well-aligned carbon nanotube films. *J. Phys. Chem. B* **103**, 4223 (1999).
15. L.T. Qu, Y. Zhao, and L.M. Dai: Carbon microfibers sheathed with aligned carbon nanotubes: Towards multidimensional, multi-component, and multifunctional nanomaterials. *Small* **2**, 1052 (2006).
16. W. Yi, L. Lu, Z. Dian-lin, Z.W. Pan, and S.S. Xie: Linear specific heat of carbon nanotubes. *Phys. Rev. B* **59**(14), R9015 (1999).

Supplementary Material

Supplementary material can be viewed in this issue of the *Journal of Materials Research* by visiting <http://journals.cambridge.org/jmr>.